

PATENT ABSTRACTS OF JAPAN

(11)Publication number : 2002-218915

(43)Date of publication of application : 06.08.2002

(51)Int.Cl.

A23L 1/00
A23L 1/01
A47J 27/00
B65D 65/42
B65D 81/34
F24C 7/02

(21)Application number : 2001-019693

(71)Applicant : MINAKAWA SHOTEN:KK

(22)Date of filing : 29.01.2001

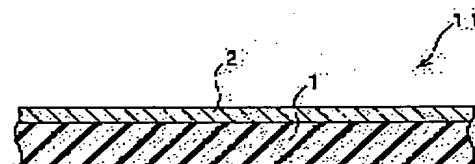
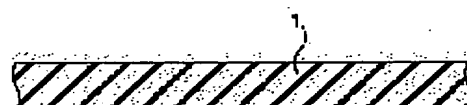
(72)Inventor : MINAGAWA HIROMICHI

(54) PACKAGING MATERIAL FOR COOKING IN MICROWAVE OVEN

(57)Abstract:

PROBLEM TO BE SOLVED: To obtain a packaging material for cooking in a microwave oven capable of sufficiently heating a food material in heat-treatment of the food material with the microwave oven, not only carrying out baking treatment producing a scorch but also eliminating operation to pickle a cooking food material in a seasoning producing the scorch and facilitating sufficient coating or impregnation of a cooked food housing material with the seasoning and designed to uniformly carry out cooking of the food material for cooking for producing the scorch with the seasoning and an edible oil and to provide a method for producing the package.

SOLUTION: This packaging material 11 for cooking in the microwave oven is obtained by coating the surface of a heat-resistant sheet material 1 with a saccharides-containing seasoning 2 which comprises a gelling agent added thereto, remains in a gel state at normal temperature and is eluted by heating and thereby supporting the saccharides-containing seasoning 2 on the surface of the heat-resistant sheet material 1.



LEGAL STATUS

[Date of request for examination] 29.01.2001

[Date of sending the examiner's decision of rejection]

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number] 3536287

[Date of registration] 26.03.2004

[Number of appeal against examiner's decision
of rejection]

[Date of requesting appeal against examiner's
decision of rejection]

[Date of extinction of right]

Copyright (C); 1998,2003 Japan Patent Office